

**DECLARATION OF JOINT INVENTORS FOR PATENT APPLICATION**

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the inventor entitled: "Etching Processes for Integrated Circuit Manufacturing Including Methods of Forming Capacitors", the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

I acknowledge the duty to disclose information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations § 1.56.

**PRIOR FOREIGN APPLICATIONS:**

I hereby state that no applications for foreign patents or inventor's certificates have been filed prior to the date of execution of this declaration.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statement may jeopardize the validity of the application or any patent issued therefrom.

\* \* \* \* \*

Full name of inventor:

Paul A. Morgan

Inventor's Signature:

*Paul A. Morgan*

Date:

*2/8/02*

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\* \* \* \* \*

Full name of inventor:

Janos Fucsko

Inventor's Signature:

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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. .... Unknown  
 Filing Date .... Filed Herewith  
 Inventor .... Paul A. Morgan et al.  
 Assignee .... Micron Technology, Inc.  
 Group Art Unit .... Unknown  
 Examiner .... Unknown  
 Attorney's Docket No. .... MI22-1798  
 Title: Etching Processes for Integrated Circuit Manufacturing Including Methods of  
 Forming Capacitors

**POWER OF ATTORNEY BY ASSIGNEE AND CERTIFICATE BY ASSIGNEE**  
**UNDER 37 CFR § 3.73(b)**

To: Assistant Commissioner for Patents  
 Washington, D.C. 20231

Sir:

**MICRON TECHNOLOGY, INC.,** the Assignee of the entire right, title and  
 interest in the above-identified patent application by assignment attached hereto,  
 hereby appoints the attorneys and agents of the firm of WELLS ST. JOHN P.S.,  
 listed as follows:

|                      |                 |
|----------------------|-----------------|
| David P. Roberts     | Reg. No. 23,032 |
| Randy A. Gregory     | Reg. No. 30,386 |
| Mark S. Matkin       | Reg. No. 32,268 |
| James L. Price       | Reg. No. 27,376 |
| Deepak Malhotra      | Reg. No. 33,560 |
| Mark W. Hendricksen  | Reg. No. 32,356 |
| David G. Latwesen    | Reg. No. 38,533 |
| George G. Grigel     | Reg. No. 31,166 |
| Keith D. Grzelak     | Reg. No. 37,144 |
| James D. Shaurette   | Reg. No. 39,833 |
| Frederick M. Fliegel | Reg. No. 36,138 |
| D. Brent Kenady      | Reg. No. 40,045 |
| James E. Lake        | Reg. No. 44,854 |
| Bernard Berman       | Reg. No. 37,279 |
| Jennifer J. Taylor   | Reg. No. 48,711 |

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and also attorneys Michael L. Lynch (Reg. No. 30,871) and Charles B. Brantley II (Reg. No. 38,086) of Micron Technology, Inc., as its attorneys with full power of substitution to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

The Assignee certifies that the above-identified Assignment has been reviewed and to the best of Assignee's knowledge and belief, title is in the Assignee, and a copy of the Assignment is submitted herewith.

Please direct all correspondence regarding this application to:

Customer No. 021567  
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MICRON TECHNOLOGY, INC.

Dated: 2/28/92

By: Roderic W. Lewis

Name: Roderic W. Lewis

Title: Vice President, Legal, General  
Counsel and Corporate Secretary

Attachment: Copy of Assignment